Effect of Electrostatic Discharge on Digital and Analog Circuits

Rajashree Narendra, M.L. Sudheer, D.C. Pande

Abstract: A comparative study of the effects of electrostatic discharge (ESD) on digital and analog circuits is carried out. Direct and Indirect discharge is performed on the circuit having both analog and digital circuitry. First the Indirect discharge on the ground plane is done for different voltages and distances. Then the direct air discharge is performed near the digital and discrete analog circuitry. These results are compared and the effect of electrostatic discharge over digital and analog circuits is summarized from the experimental results.

Keywords: Electrostatic Discharge; Indirect discharge; Direct air discharge; Analog circuit; Digital circuit; ESD simulator; Electromagnetic Interference

I. INTRODUCTION

Digital circuits are more susceptible to electrostatic discharge (ESD) than analog circuits. Most of the electronic components that are considered fairly rugged can be damaged by ESD. Bipolar transistors, the earliest of the solid state amplifiers, are not immune to ESD, though less susceptible. There are components that might not be considered at risk, such as some specialized resistors and capacitors. Devices manufactured using MOS (Metal Oxide Semiconductor) technology is more susceptible to ESD [1-4] but some of the newer high speed components can be ruined with low voltages.

Damage to components can, and usually do, occur when the part is in the ESD path. Many components in the circuits are very robust, can handle the discharge and undergo upsets. But if a part has a small or thin geometry as part of their physical structure then the voltage can break down that part of the semiconductor [5-8]. Currents during the ESD events become quite high, but are in the nanosecond to microsecond time frame. Part of the component is left permanently damaged by this, which can cause two types of failure modes. Catastrophic is the easy one, leaving the part completely nonfunctional. The other can be much more serious. Latent damage may allow the problem component to work for hours, days or even months after the initial damage before catastrophic failure. Many times these parts are referred to as "walking wounded", since they are working but bad. If these components end up in a life support role, such as medical or military use, then the consequences can be grim.

Indirect discharge on the horizontal coupling plane (HCP) and direct air discharge is performed [9,10]. The ESD indirect discharge test was carried out to verify the ESD immunities of the analog and digital components in the circuit.

II. CIRCUIT DIAGRAM AND ITS OPERATION

The RC Phase Shift Oscillator produces a sine wave output signal using regenerative feedback from the resistor-capacitor combination. This resistor-capacitor feedback network is connected as shown in the Fig. 1 as a phase advance network to produce a sine wave oscillation at a frequency of 912Hz with an overall phase-shift of 360 degrees. By varying one or more of the resistors or capacitors in the phase-shift network, the frequency can be varied and generally this is done using a 3-ganged variable capacitor. As the resistor-capacitor combination in the RC Oscillator circuit also acts as an attenuator producing an attenuation of -1/29th (Vo/Vi = β) per stage, the gain of the amplifier is adjusted sufficiently large to overcome the losses in the three mesh network.

Zero-crossing detector using inverting op-amp (IC µA741) comparator is depicted in Fig. 1. The circuit produces a change in the output state whenever the input crosses the reference. In this case the reference input is ground, hence every time the sine wave output crosses the 0V level there will be a shift in the output voltage level.

Fig. 1 Circuit diagram of RC phase-shift oscillator followed by zero crossing detector.
The initial output of the circuit is shown in Fig. 2. The sine wave is the output of the oscillator, the two square waves are the output of the zero crossing detector.

III. INDIRECT ESD DISCHARGE

Indirect discharge was done on the horizontal plane for different voltages and different distances. Some of them are presented and discussed. When a discharge of 4kV was given on the horizontal plane at a distance of 0.9m there was a change in the ZCD output for 6.67µs indicating shift of the oscillator output below 0V for that period of time as shown in Fig. 3.

The oscillator output goes below the reference voltage of 0V twice when discharged at 8kV at a distance of about 0.9 m as shown in the Fig. 4. At the first instance it is for a period of about 2µs and second instance for a period of 1µs which is indicated by the shift of the ZCD output.

A small phase shift and a transient of about 13V is observed at the trigger point in the oscillator output when discharged at 15kV at a distance of 0.9m as shown in Fig. 5. But a very small transient of about 1V is observed in the ZCD output because of the data being low at the point of trigger.
The results tabulated are for different voltages at a constant distance of 0.9m from the circuit.

<table>
<thead>
<tr>
<th>Voltage</th>
<th>Discharge Distance</th>
<th>Change in ZCD Output and Phase Shift</th>
<th>Oscillator Output</th>
</tr>
</thead>
<tbody>
<tr>
<td>4kV</td>
<td>0.9m</td>
<td>6.67µs</td>
<td>Oscillator output went below 0V twice and shift in ZCD output for 2µs</td>
</tr>
<tr>
<td>8kV</td>
<td>0.9m</td>
<td>1V transient for ZCD output and 13V transient in oscillator output</td>
<td></td>
</tr>
<tr>
<td>15kV</td>
<td>0.9m</td>
<td>1V transient for ZCD output and 13V transient in oscillator output</td>
<td></td>
</tr>
</tbody>
</table>

Now the results for a constant voltage of 8kV at different distances are discussed. The effect of ESD for 8kV at a distance of 0.9 m is already mentioned in Fig. 4. When 8kV is discharged at a distance 0.7m, a transient of about 9V and a very small phase shift at the point of trigger is seen and the data goes below 0V for 3 µs as shown in Fig. 6. The data also goes beyond the maximum reference level at the instance of trigger which is seen by the shift in the ZCD output.

When discharged at a distance of 0.5m as shown in Fig. 7, there is a data shift for 5 µs in the ZCD output showing the transient going below 0V at that moment, followed by a small phase shift at the point of trigger.
The results tabulated are for different distances at a constant voltage of 8kV from the circuit.

<table>
<thead>
<tr>
<th>8kV discharge at 0.9 m</th>
<th>8kV discharge at 0.7 m</th>
<th>8kV discharge at 0.5 m</th>
</tr>
</thead>
<tbody>
<tr>
<td>Oscillator output went below 0V twice and shift in ZCD output for 2µs and 1 µs</td>
<td>a very small phase shift at the point of trigger and shift in ZCD output for 3µs</td>
<td>a very small phase shift at the point of trigger and shift in ZCD output for 5µs</td>
</tr>
</tbody>
</table>

IV. DIRECT AIR DISCHARGE

Discharge at the ZCD output

The following results are observed when air discharge is conducted near the ZCD output of the circuit. There is a transient greater than the reference voltage at the oscillator output for 20 µs which is indicated by the shift at the ZCD output. A phase shift and an increase in the amplitude of the next peak by 1V are observed in the oscillator output when discharged at 2kV. This is shown in Fig. 8.

![Fig. 8 Effect of ESD at ZCD output for 2kV](image)

When discharged at 4kV the oscillator output has a large transient and a 180 degree phase shift indicated by the ZCD output shift. Also a decrease in the negative peak amplitude and an increase in the peak amplitude of the next cycle are observed as shown in Fig. 9.

After a discharge of 15kV at the ZCD output, the digital circuit initially works fine indicating the transition of the oscillator output below the reference voltage. But eventually only the oscillator output recovers and remains intact but both the square wave output and the ZCD output goes to negative saturation around -10V and the IC µA741 is spoilt. This is depicted in the Fig. 10.

![Fig. 9 Effect of ESD at ZCD output for 4kV](image)

![Fig. 10 Effect of ESD at ZCD output for 15kV](image)
The results are tabulated for air discharge at ZCD output.

<table>
<thead>
<tr>
<th>Discharge Voltage</th>
<th>ZCD Output Effect</th>
<th>Oscillator Output Effect</th>
</tr>
</thead>
<tbody>
<tr>
<td>2kV</td>
<td>ZCD output shift for 20µs, oscillator suffers a phase shift and increase in amplitude there after</td>
<td>Shift in ZCD output and 180° phase shift and amplitude change for oscillator output</td>
</tr>
<tr>
<td>4kV</td>
<td>Phase shift in oscillator output and then recovers, ZCD output goes to negative saturation</td>
<td></td>
</tr>
</tbody>
</table>

**Discharge at the Oscillator output**

When a 2kV air discharge is given to the pickup point at oscillator output the sine wave had a large transient which is indicated by the shift in the ZCD and there is an increase in the amplitude by 2V in the next peak of the sine wave. This is shown in Fig. 11.

A discharge of 4kV at the oscillator output results in a transient greater than 60V at the oscillator output followed by an increase in the negative peak voltage greater than 0V, also observed is the shift in the ZCD output for 60 µs and an increase in the peak voltage of the next peak by 2V. This is shown in Fig. 12.

![Fig. 11 Effect of ESD at oscillator output for 2kV](image11.png)

![Fig. 12 Effect of ESD at oscillator output for 4kV.](image12.png)

A discharge of 8kV at the oscillator output results in a transient which goes below the reference voltage for 40 µs and then the oscillator output remains above the reference voltage for 750 µs. Also the ZCD output remains high for entire period of 750 µs as shown in Fig. 13.

When discharged for 15kV the oscillator output goes below 0V for 40 µs. A large transient at the ZCD after 40 µs shows that the oscillator output goes below and beyond the reference after which the oscillator output remains above 0V for 1.7 ms after which it regains its original functionality. Meanwhile the ZCD output remains at high till analog output recovers. This is shown in Fig. 14. The analog circuit output recovered earlier compared to the digital output.

![Fig. 13 Effect of ESD at oscillator output for 8kV.](image13.png)
Fig. 14 Effect of ESD at oscillator output for 15kV

The results are tabulated for air discharge at oscillator output.

<table>
<thead>
<tr>
<th>Discharge Voltage</th>
<th>2KV at 0.9m</th>
<th>4Kv at 0.9m</th>
<th>8Kv at 0.9m</th>
<th>15Kv at 0.9m</th>
</tr>
</thead>
<tbody>
<tr>
<td>2V increase in amplitude and shift in ZCD output</td>
<td>Oscillator output has 60V transient, 2V increase in amplitude and ZCD output change for 60 µs</td>
<td>Oscillator output goes below reference for 40 µs, oscillator and ZCD output remain high for 750µs</td>
<td>Oscillator output below 0V for 40 µs and ZCD has huge transient and remains high till analog recovers</td>
<td></td>
</tr>
</tbody>
</table>

V. CONCLUSIONS

The effect of ESD on the digital data is more pronounced when compared to the analog data. From the above experimental results it can be definitely said that the digital data is more susceptible to ESD due to its smaller size and larger complexity when compared to the analog circuits. It can be seen that the analog circuit can come back to its initial working condition (even sometimes after certain latency period due to the slow discharge of charges accumulation) even after the ESD affecting it, but a digital circuit gets damaged quickly to electrostatic discharge.

In the indirect discharge it is seen that the ESD effect depends on both the distance and the discharge voltage. Higher discharge voltage and shorter distance produces larger data losses and larger transients. The digital circuit gets damaged at higher discharge voltage. The analog circuit with discreet components is affected by ESD but it recovers back quickly.

REFERENCES